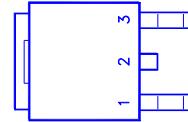
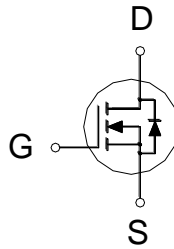




- 1. GATE
- 2. DRAIN
- 3. SOURCE

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	140mΩ	10A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	$T_C = 25\text{ °C}$	I_D	10	A
	$T_C = 100\text{ °C}$		7	
Pulsed Drain Current ¹		I_{DM}	30	
Avalanche Current		I_{AS}	10	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	5	mJ
Power Dissipation	$T_C = 25\text{ °C}$	P_D	35	W
	$T_C = 100\text{ °C}$		14	
Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		3.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ °C}$, Unless Otherwise Noted)

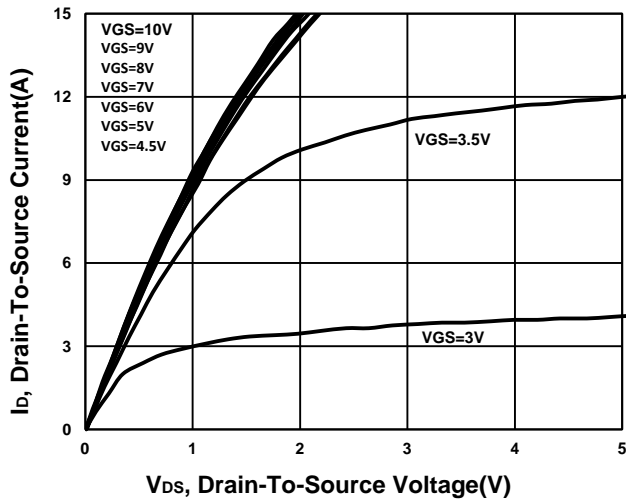
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.3	1.9	2.3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 80V, V_{GS} = 0V$			1	μA
		$V_{DS} = 80V, V_{GS} = 0V, T_J = 125\text{ °C}$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 5A$		103	170	mΩ
		$V_{GS} = 10V, I_D = 5A$		93	140	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 10V, I_D = 5A$		13		S

DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		330		pF
Output Capacitance	C_{oss}			50		
Reverse Transfer Capacitance	C_{rss}			22		
Total Gate Charge ²	Q_g	$V_{GS} = 10V,$ $V_{DS} = 50V, I_D = 5A$		8.6		nC
Gate-Source Charge ²	Q_{gs}			1.2		
Gate-Drain Charge ²	Q_{gd}			3.5		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 50V$ $I_D \cong 5A, V_{GS} = 10V, R_{GEN} = 6\Omega$		22		nS
Rise Time ²	t_r			60		
Turn-Off Delay Time ²	$t_{d(off)}$			30		
Fall Time ²	t_f			40		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current	I_S				10	A
Forward Voltage ¹	V_{SD}	$I_F = 5A, V_{GS} = 0V$			1.1	V
Reverse Recovery Time	t_{rr}	$I_F = 5A, di_F/dt = 100A / \mu S$		25		nS
Reverse Recovery Charge	Q_{rr}			25		nC

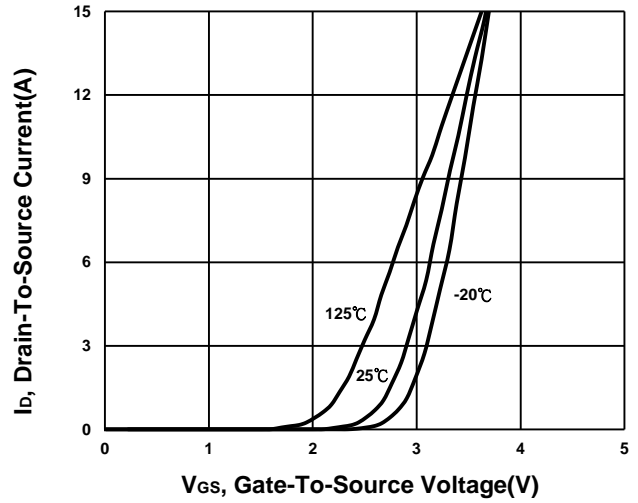
¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

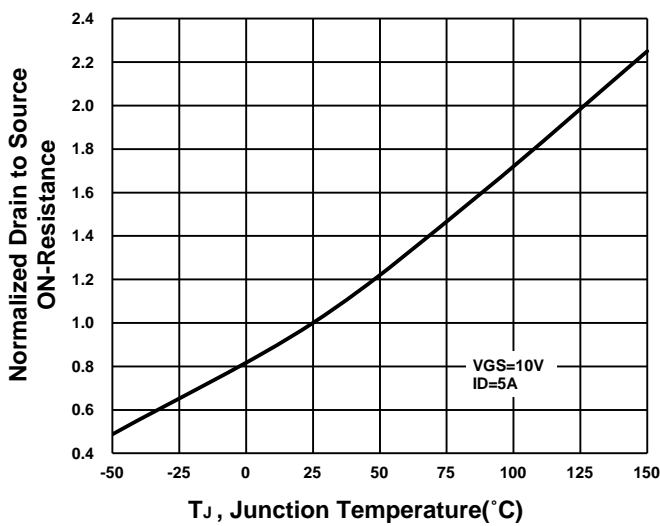
Output Characteristics



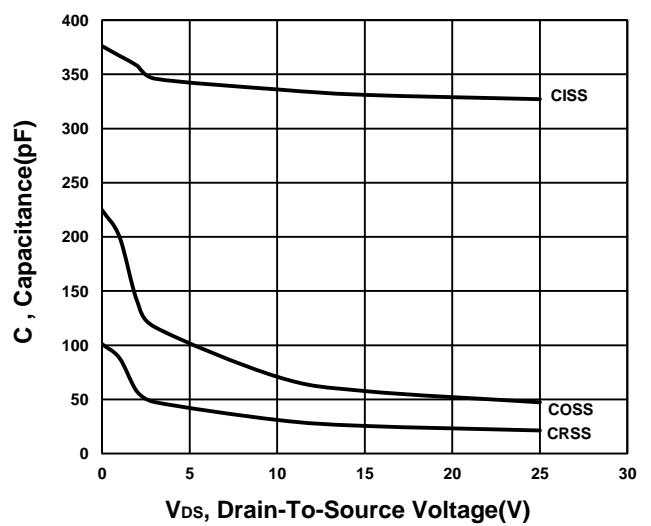
Transfer Characteristics



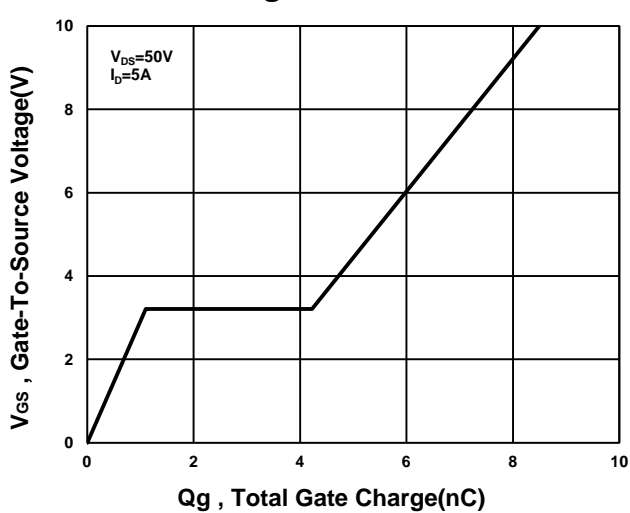
On-Resistance VS Temperature



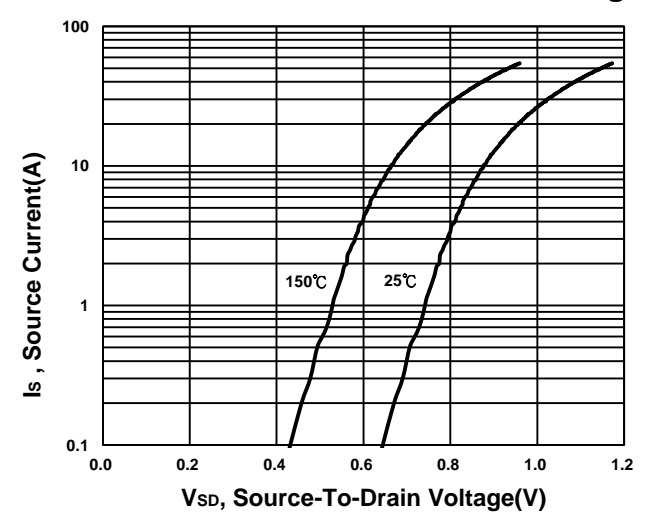
Capacitance Characteristic



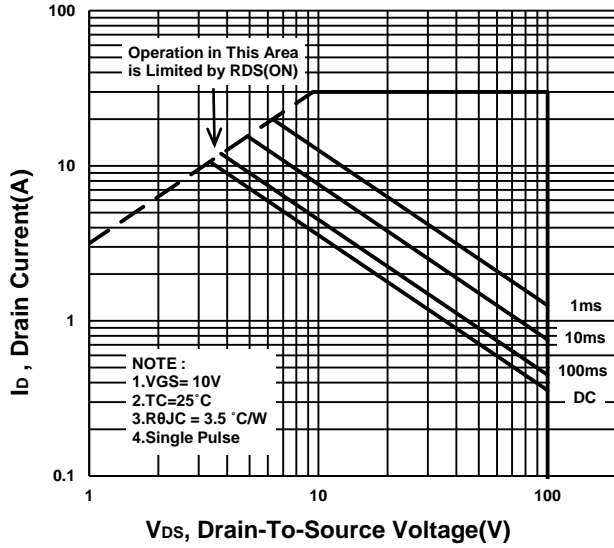
Gate charge Characteristics



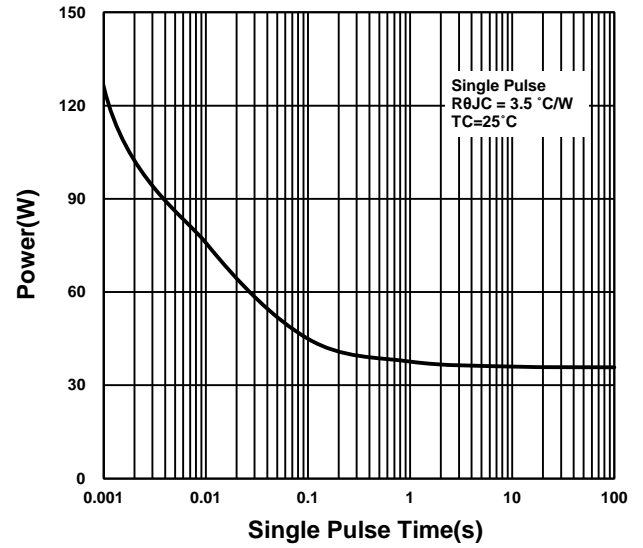
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

